

HSP

NOTES:

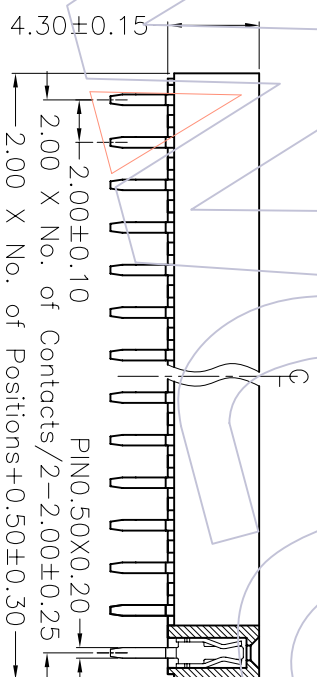
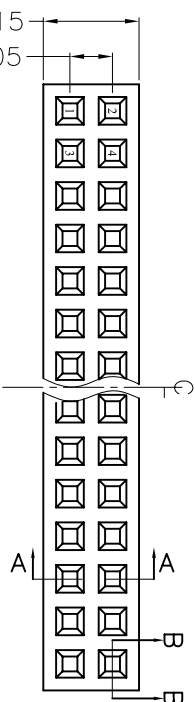
Current Rating: 2.0AMP
 Withstand Voltage: 500V AC/DC
 Contact Resistance: 20mΩ Max
 Insulation Resistance: 1000MΩ Min
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze
 Contact plating: Au or Sn over Ni
 Insulator Material: PA6T+30%G, F UL94V-0

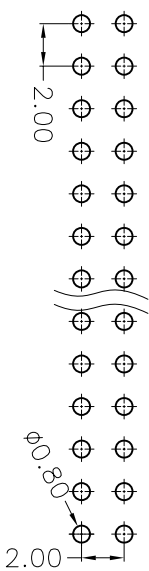
Ordering Information

2243 - 2 XX S XX CUNT 1

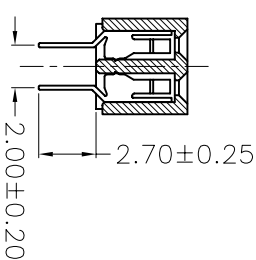
No. of Pins per ROW: 42~40Pin
 Contact Plating: G0=Gold Flash, G1=5μ"Gold, G2=5μ"Gold, G3=10μ"Gold, G4=15μ"Gold, G5=30μ"Gold
 Contact Finish: S0=Gold Flash/Tin, S1=5μ"Gold/Tin, S2=5μ"Gold/Tin, S3=10μ"Gold/Tin, S4=15μ"Gold/Tin, S5=30μ"Gold/Tin, SN=Tin
 Packing: T=Tube, CAP, P=Tube+CAP, R=Tube&Rect+CAP



SECTION B-B



Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



SECTION A-A

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	SCALE	PART NO.	TITLE:
A0	08/02/28	NEW			X.X ±0.40 X.XX ±0.25 X.XXX ±0.15 Angle ± 3'	MaLiS DESIGN CHECK APPROVE	3:1 mm A4 1/1	2243-2XXSXXCUNT1	FH2.00mm DUAL 180° H=4.3
1									

WCON 维峰五金电子有限公司
 WAFER HARDWARE ELECTRONICS CO., LTD